## 06/24/04

07-06-2004



P/4076-82

PATENTS F		
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Name of conveying party(ies):	Name and Address of receiving party(ies):	
1. Loon Aik LIM 2. Charles J. VATH III	ASM Technology Sinagpore Pte Ltd 2 Yishun Avenue 7 Singapore 768924	
Type of Entity: Individual	Type of Entity: Corporation - Singapore	
Additional names(s) of conveying party(ies) attached? No	Additional name(s) & address(es) No attached?	
3. Nature of Conveyance:		
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Execution Date: 1. June 8, 2004 2. June 8, 2004		
Application number(s) or patent number(s):  If this document is being filed together with a new application, the execution date of the application is:  June 8, 2004		
A. Application No.(s)	B. Patent No.(s)	
10/877079 Additional numbers at	 tached? No	
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Max Moskowitz  Name of Person Signing  Signing	June 24, 2004  Date	
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**PATENT REEL: 015524 FRAME: 0486**  PATENT APPLICATION ASSIGNMENT - SOLE AND JOINT INVENTORS EXECUTED OUTSIDE USA

OFGS FILE NO. \_\_P/4076-82\_\_\_\_

WHEREAS, we, Loon Aik LIM and Charles J. VATH III as assignors, have invented certain improvements in CAPILLARY FOR WIRE BONDING for which an application for United States Letters Patent has been executed by me of even date herewith; and

WHEREAS, ASM Technology Singapore Pte Ltd, a corporation organized and existing under the laws of Singapore and having a principal place of business at 2 Yishun Avenue 7, Singapore 768924 as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I, as assignor, hereby sell, assign and set over to said assignee the entire right, title and interest for the United States and all other countries in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute or reissue applications and patents applied for or granted therefor in the United States and all other countries, including all rights of priority from the filing of said application, and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself and my legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be borne and paid by said assignee.

Date:	8/06/04	had
•		Loon Aik LIM
Date:	8/01/24	Charles Vetto
•		Charles J. VATH III
Date:		

RECORDED: 06/24/2004

PATENT REEL: 015524 FRAME: 0487